

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Ambient Temperature with Power Applied	–40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only)....	–0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only) .	–0.5V to +7.0V
DC Input Voltage	–0.5V to +7.0V
DC Output Current.....	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, T_A = –40°C to +85°C, V_{CC} = 5V ±5%)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	–0.5		0.8	
I _{IH}	Input HIGH Current	V _{CC} = Max., V _{IN} = V _{CC}			±1	μA
I _{IL}	Input LOW Current	V _{CC} = Max., V _{IN} = GND			±1	
I _{OZH}	High Impedance Output Current	0 ≤ I, Y ≤ V _{CC}			±1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = –18 mA		–0.7	–1.2	V
I _{OS}	Short Circuit Current ⁽³⁾	I (Y) = 0V, Y (I) = V _{CC}	100			mA
V _H	Input Hysteresis at Control Pins			150		mV
R _{ON}	Switch On-Resistance ⁽⁴⁾	V _{CC} = Min., V _{IN} = 0.0V, I _{ON} = 48mA		5	7	Ω
		V _{CC} = Min., V _{IN} = 2.4V, I _{ON} = 15mA		10	15	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, T_A = 25°C ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Measured by the voltage drop between I and Y pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (I,Y) pins.

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Typ	Max.	Units
C _{IN}	Input Capacitance	V _{IN} = 0V		6	pF
C _{OFF}	In/Yn Capacitance, Switch Off			6	
C _{ON}	In/Yn Capacitance, Switch On			14	

Notes:

- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		0.1	3.0	μA
ΔI _{CC}	Supply Current per Input @ TTL HIGH	V _{CC} = Max.	V _{IN} = 3.4V ⁽³⁾			2.5	mA
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} = Max., I and Y Pins Open $\overline{BE}$ = GND Control Input Toggling 50% Duty Cycle				0.25	mA/ MHz

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V, control inputs only); I and Y pins do not contribute to I_{CC}.
4. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The I and Y inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

Switching Characteristics over Operating Range

Parameters	Description	Conditions	Com.		Units
			Min.	Max.	
t _{IY}	Propagation Delay ^(1,2) In to Yn	C _L = 50pF R _L = 500Ω		0.25	ns
t _{SY}	Bus Select Time Sn to Yn		0.5	5.2	
t _{PZH} t _{PZL}	Bus Enable Time $\overline{E}$ to Yn		0.5	4.8	
t _{PHZ} t _{PLZ}	Bus Disable Time $\overline{E}$ to Yn		0.5	5.0	

Notes:

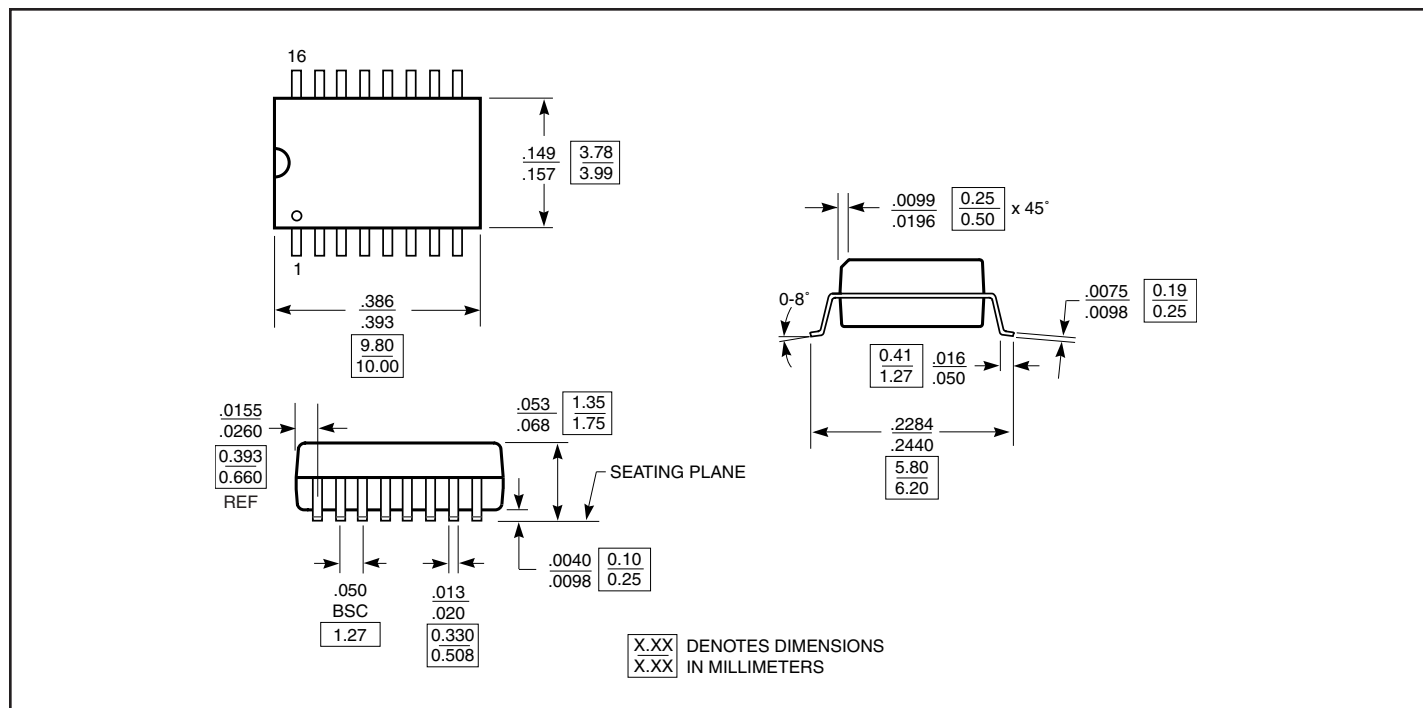
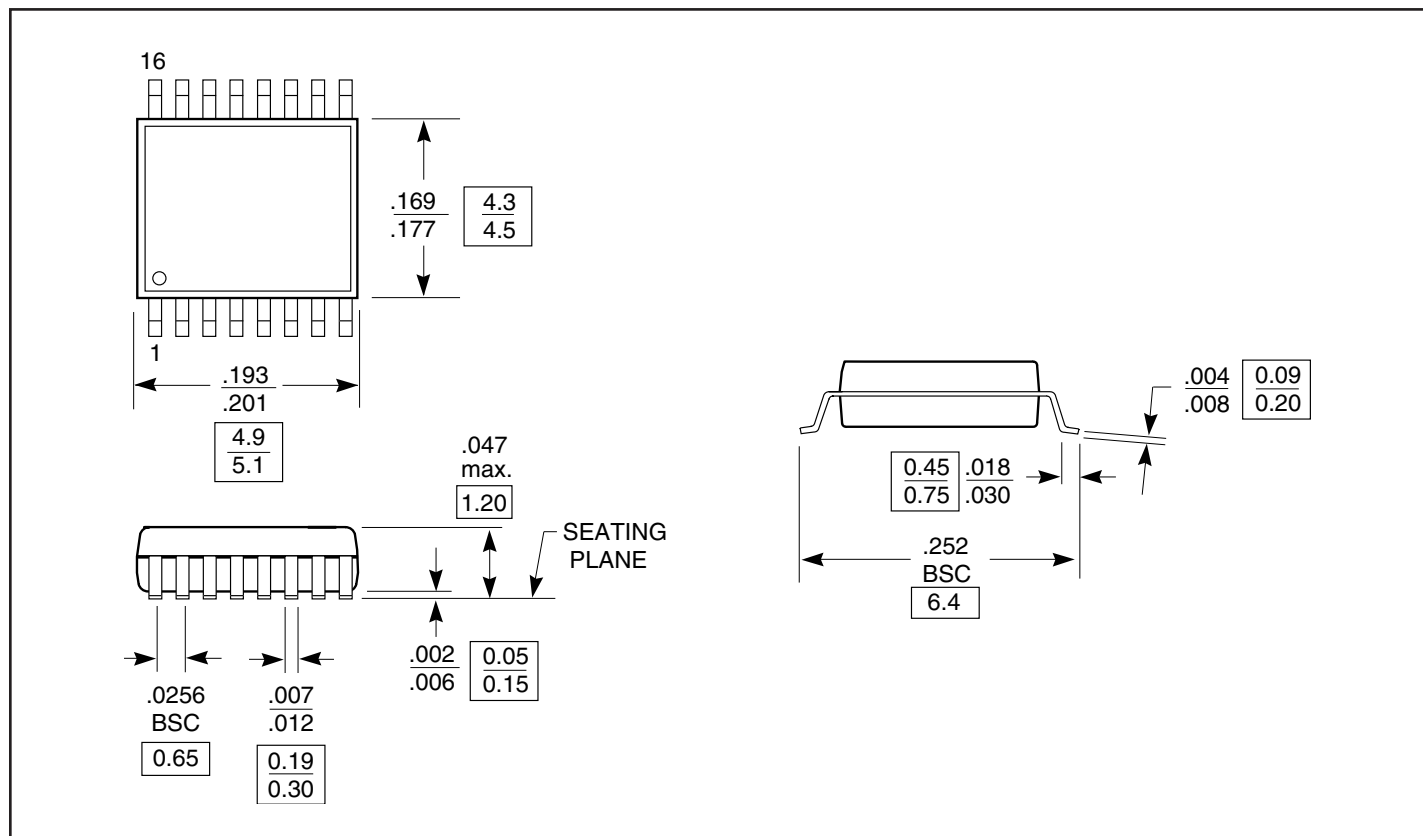
1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

Figure 1: Mechanical drawings of the 16-pin connector. The top drawing shows the front view with dimensions for pin pitch (.189/.197), pin width (.025/.035), and overall width (4.80/5.00). The bottom drawing shows the side view with dimensions for pin height (.053/.069), pin thickness (.008/.012), and overall height (1.35/1.75). The right side shows two detail views: Detail A shows the top profile with dimensions for pin height (.016/.035), pin thickness (.008/.013), and overall height (1.03 REF). Detail B shows the bottom profile with dimensions for pin height (.016/.035), pin thickness (.008/.013), and overall height (1.03 REF).

The mechanical drawings of the 16-pin DIP package are as follows:

- Top View:** Shows a rectangular package with 16 pins (8 on each side). Pin 1 is indicated by a dot. Dimensions include a width of .398" (10.10 mm) to .413" (10.50 mm) and a height of .2914" (7.40 mm) to .2992" (7.60 mm).
- Side View:** Shows the package profile with a maximum height of .0926" (2.35 mm) to .1043" (2.64 mm) from the seating plane. The pin height is .020" (0.508 mm) to .030" (0.762 mm). The pin pitch is .050" (1.27 mm) BSC.
- End View:** Shows the package from the side, highlighting the .0040" (0.10 mm) to .0118" (0.30 mm) gap between the package body and the pins. The pin height is .013" (0.33 mm) to .020" (0.51 mm).
- Detail View:** Shows the pin profile with a .010" (0.254 mm) to .029" (0.737 mm) width at the top, a .0091" (0.23 mm) to .0125" (0.32 mm) thickness at the base, and a .016" (0.41 mm) to .050" (1.27 mm) width at the base. The pin is angled at 45° and has a 0-8° lead angle.

Legend: X.XX / X.XX DENOTES DIMENSIONS IN MILLIMETERS

Packaging Mechanical: 16-pin SOIC (W)

Packaging Mechanical: 16-pin TSSOP (L)


Ordering Information

Ordering Code	Packaging Code	Package Description
PI5C3257Q	Q	16-pin 150 mil wide plastic QSOP
PI5C3257QE	Q	Pb-free & Green, 16-pin 150-mil wide plastic QSOP
PI5C3257S	S	16-pin 300-mil wide plastic SOIC
PI5C3257SE	S	Pb-free & Green, 116-pin 300-mil wide plastic SOIC
PI5C3257W	W	16-pin 150-mil wide plastic SOIC
PI5C3257WE	W	Pb-free & Green, 16-pin 150-mil wide plastic SOIC
PI5C3257L	L	16-pin 173-mil wide plastic TSSOP
PI5C3257LE	L	Pb-free & Green, 16-pin 173-mil wide plastic TSSOP

Notes:

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free & Green
- Adding an X suffix = Tape/Reel